SHIGA7.004APC PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Maruyama et al.

Appl. No. : 10/522,036

Filed: January 19, 2005

For : CHEMICAL AMPLIFICATION

TYPE POSITIVE PHOTORESIST COMPOSITION AND RESIST PATTERN FORMING METHOD

Examiner : Lee, Sin J

Group Art Unit : 1752

AMENDMENT AND RESPONSE TO ADVISORYACTION AND FINAL OFFICE ACTION

Mail Stop AF

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Advisory Action mailed **December 26**, **2006**, and the Office Action mailed **September 15**, **2006**, please consider the following amendments and remarks.

Amendments to the claims begin on page 2 of this paper.

Remarks begin on page 13 of this paper.